

042N100TA / 042N100TB

100V N-Channel Super Trench Power MOSFET



Description

042N100T is uses Super Trench technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

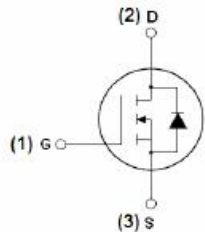
- Excellent gate charge x $R_{DS(on)}$ product(FOM)
- Very low on-resistance $R_{DS(on)}$
- Pb-free lead plating



042N100TA



042N100TB



MAIN CHARACTERISTICS

ID	110A
VDSS	100v
$R_{DS(ON)Typ}$ (at $V_{GS}=10V$) TO-220	3.7m Ω
$R_{DS(ON)Typ}$ (at $V_{GS}=10V$) TO-263	3.6m Ω

Application

- DC/DC Converter
- Ideal for high-frequency
- Switching and synchronousrectification

Absolute maximum ratings

Symbol	Parameter	042N100TA	042N100TB	Unit
V_{DSS}	Drain-source voltage	100		V
V_{GSS}	Gate-Source Voltage	± 20		V
I_D	Drain Current -continuous($T_C=25^{\circ}C$)	110		A
	Drain Current -continuous($T_C=100^{\circ}C$)	95		
I_{DM}	Drain Current-Pulsed	520		A
P_D	Power Dissipation	$T_C=25^{\circ}C$	220	W
		Derating factor	1.43	W/ $^{\circ}C$
E_{AS}	Single pulsed avalanche energy (Note5)	750		mJ

Thermal Characteristics

Symbol	Parameter	042N100TA	042N100TB	Units
$R_{\theta JC}$	Thermal Resistance, Juction-to-Case (Note2)	0.67		$^{\circ}C/W$
$R_{\theta JA}$	Thermal Resistance, Juction-to-Ambient	52		$^{\circ}C/W$

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Electrical Characteristics $T_c=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max	Unit
Off Characteristics						
BV_{DSS}	Drain Source breakdown voltage	$V_{GS}=0V, I_D=250\mu A, T_J=25^{\circ}\text{C}$	100	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=100V, V_{GS}=0V$	-	-	1	μA
I_{GSS}	Gate-to-Source Forward Leakage	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 200	nA

On Characteristics (Note 3)

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2		4	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=50A$	TO-220	-	3.7	4.2 $m\Omega$
			TO-263	-	3.6	4.2 $m\Omega$
G_{FS}	Forward Transconductance	$V_{DS}=5V, I_D=50A$	-	90	-	S

Dynamic Characteristics (Note 4)

C_{iss}	Input Capacitance	$V_{DS}=50V, V_{GS}=0V, F=1MHz$	-	6998	-	pF
C_{oss}	Output Capacitance		-	892	-	pF
C_{rss}	Reverse Transfer Capacitance		-	32	-	pF

SWITCHING Characteristics (Note 4)

$T_{D(on)}$	Turn-on Delay Time	$V_{DD}=50V, I_D=50A, RG=1.6\Omega, V_{GS}=10V$	-	22	-	ns
T_r	Turn-on Rise Time		-	11.8	-	ns
$T_{D(off)}$	Turn-off Delay Time		-	46	-	ns
T_f	Turn-off Fall Time		-	10.5	-	ns
Q_g	Total Gate Charge	$V_{DS}=50V, I_D=100A, V_{GS}=10V$	-	106	-	nC
Q_{gs}	Gate Source Charge		-	36	-	nC
Q_{gd}	Gate Drain Charge		-	25	-	nC

Drain-Source Diode Characteristics and Maximum Ratings

V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS}=0V, I_S=50A$	-	-	1.2	V
T_{rr}	Reverse Recovery Time	$T_J=25^{\circ}\text{C}, V_R=50V, I_F=30A, di/dt=100A/\mu S$ (Note3)	-	155	-	ns
Q_{rr}	Reverse Recovery Charge		-	390	-	μC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse test: Pulse Width $\leq 300\mu S$, Duty Cycle $\leq 2\%$
4. Guaranteed by design, not subject to production
5. EAS condition: $T_J=25^{\circ}\text{C}, V_{DD}=50V, V_G=10V, L=0.5mH, R_g=25\Omega$

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)

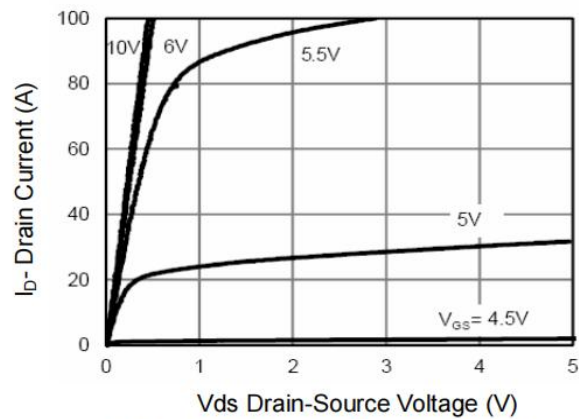


Figure 1 Output Characteristics

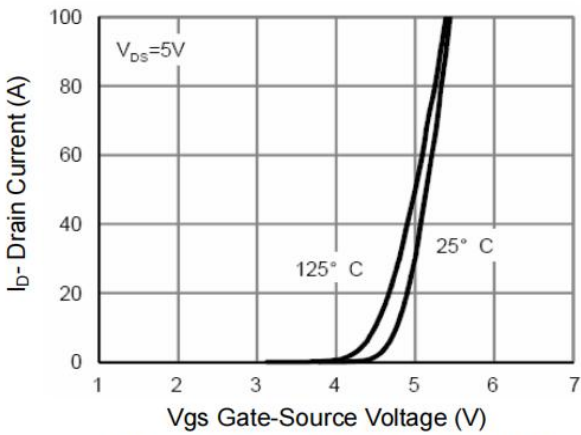


Figure 2 Transfer Characteristics

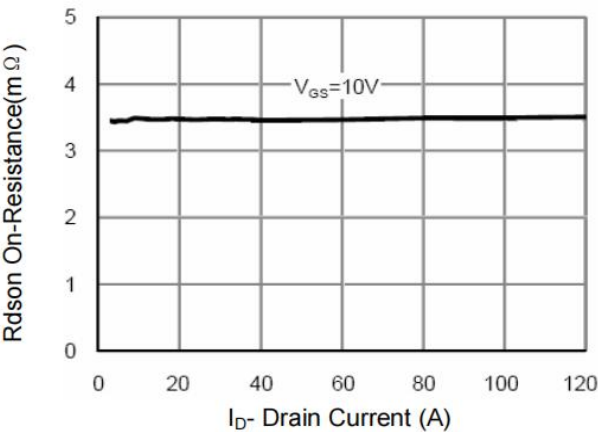


Figure 3 Rdson- Drain Current

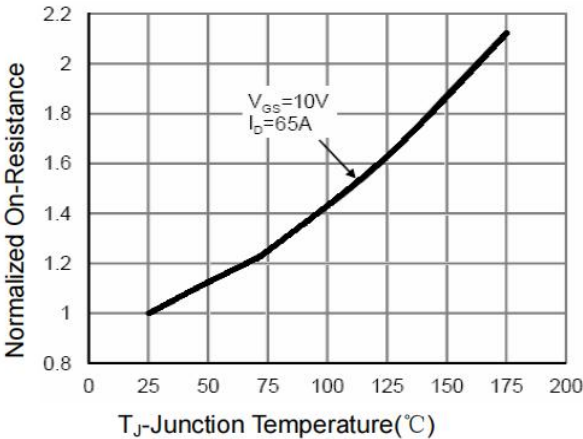


Figure 4 Rdson-Junction Temperature

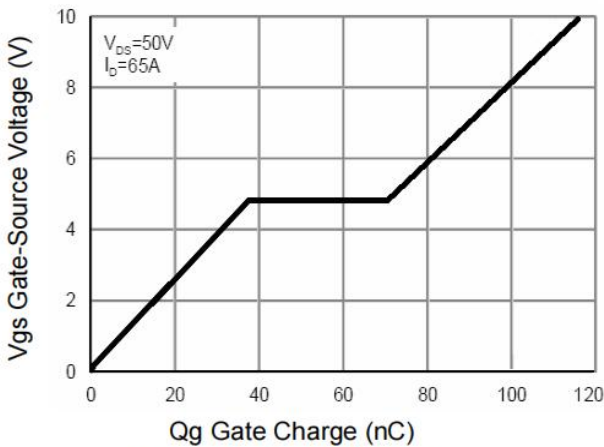


Figure 5 Gate Charge

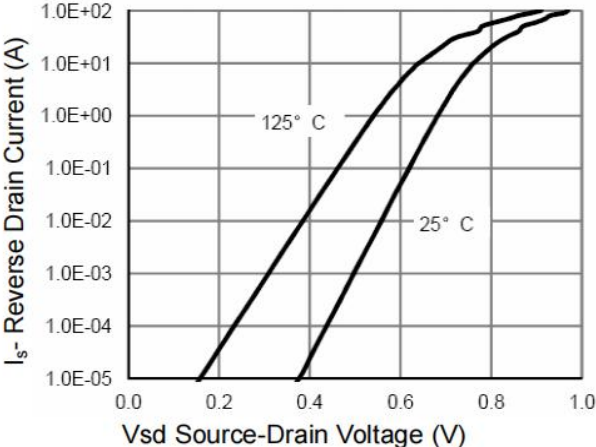
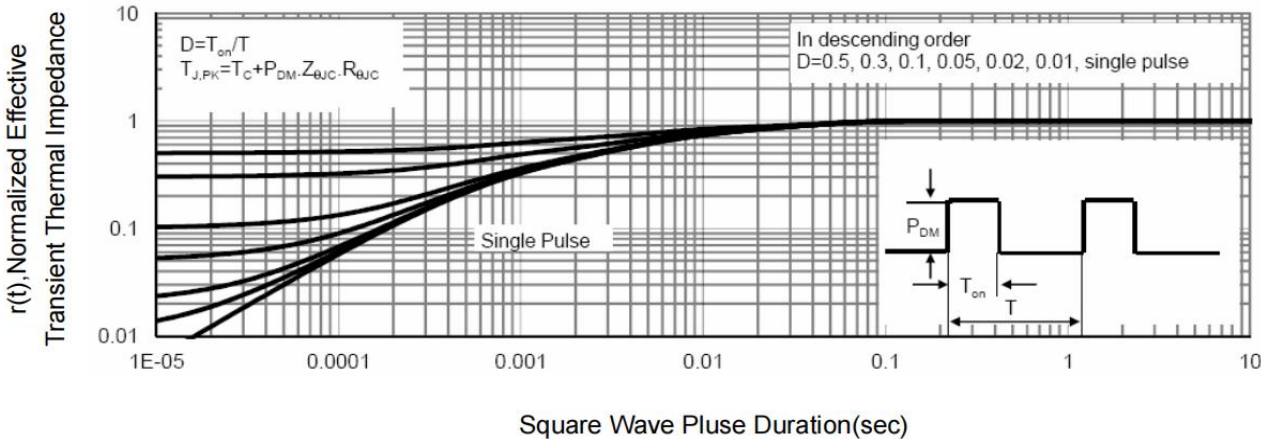
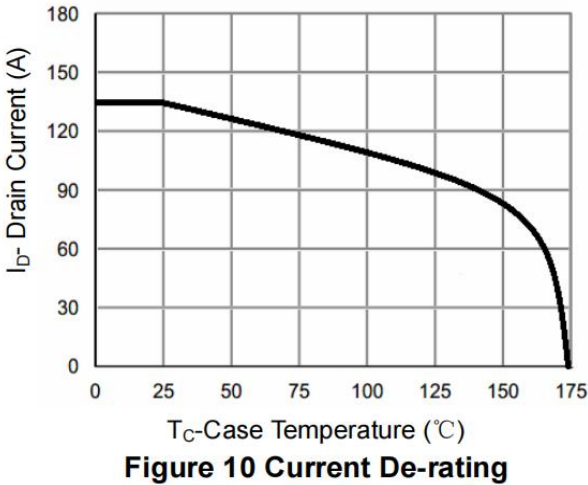
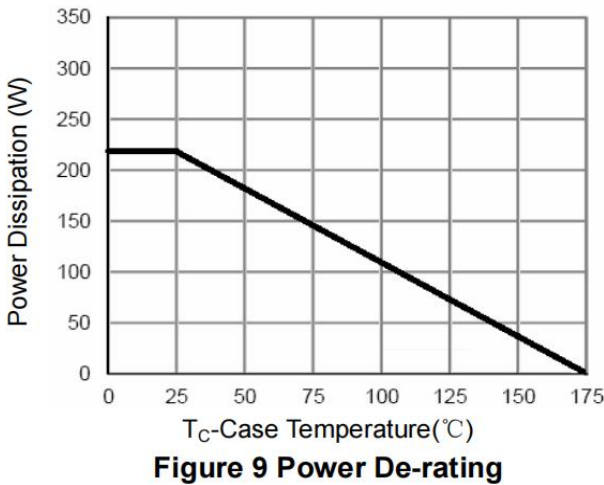
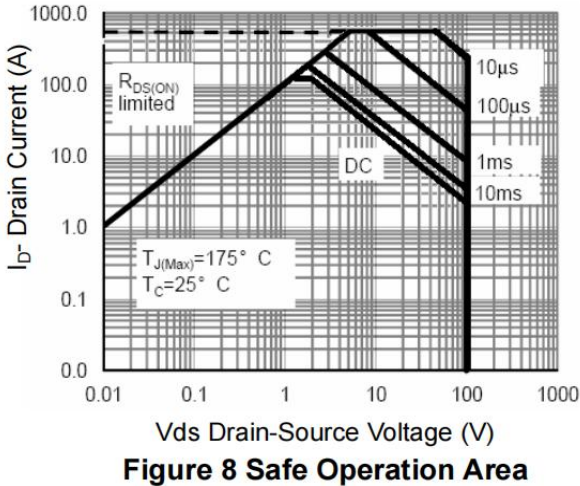
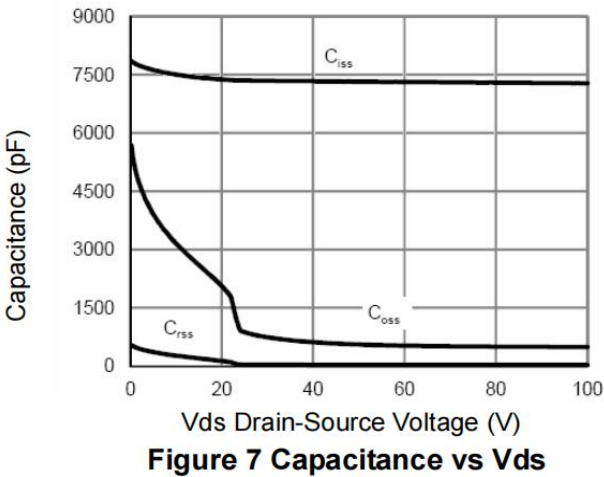


Figure 6 Source- Drain Diode Forward

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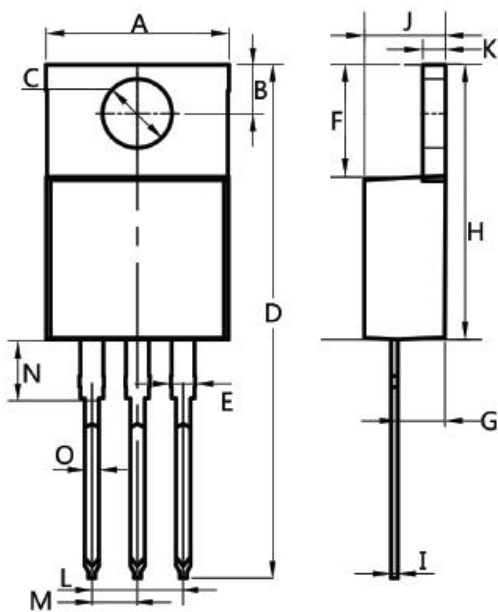


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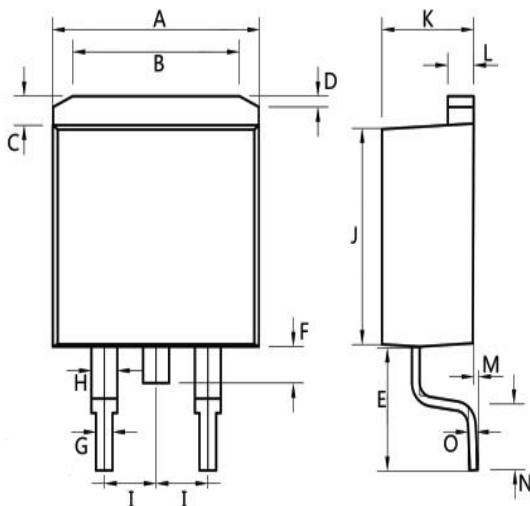
Package Outline

T0-220 封装尺寸 (Package size)



Dim	Min	Max
A	10	10.4
B	2.5	3
C	3.5	4
D	28	30
E	1.1	1.5
F	6.2	6.6
G	2.9	3.3
H	15	16
I	0.35	0.45
J	4.3	4.7
K	1.2	1.4
L	Typ 5.08	
M	Typ 2.54	
N	3.1	3.5
O	0.7	0.9
P	10	10.4

T0-263 封装尺寸 (Package size)



Dim	Min	Max
A	10	10.5
B	7.25	7.75
C	1.3	1.5
D	0.55	0.75
E	5	6
F	1.4	1.6
G	0.75	0.95
H	1.15	1.35
I	TYP 2.54	
J	8.4	8.6
K	4.4	4.6
L	1.25	1.45
M	0.02	0.1
N	2.4	2.8
O	0.35	0.45